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wherein a distance defined between, said wiring section and said electromagnetic shielding film is 50  $\mu\text{m}$  or less, a volume specific resistance of said electromagnetic shielding film is 30  $\mu\Omega\cdot\text{cm}$  or less at room temperature, and

wherein, over an applicable frequency between about 10MHz to 15GHz, and inductance of said wiring section and inductive cross talk are reduced.

Please add the following new claims 10-14:

--10. A circuit board for electronic parts, comprising:

a plate-like ground layer;

an insulating substrate disposed on said plate-like ground layer;

a plurality of leads disposed on the insulating substrate; and

a conductor disposed on an insulating material on said plurality of leads,

wherein said conductor disposed on said insulating material on said plurality of leads reduces a self inductance of said plurality of leads by flowing eddy current through said conductor,

wherein a distance defined between said plurality of leads and said conductor is 50  $\mu\text{m}$  or less, a volume specific resistance of said conductor is 30  $\mu\Omega\cdot\text{cm}$  or less at room temperature, and

wherein, over an applicable frequency between about 10MHz to 15GHz, said insulating substrate disposed on said plate-like ground layer reduces a self-inductance of said plurality of leads by flowing eddy current through said plate-like ground layer.

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11. The circuit board for electronic parts as claimed in claim 10, wherein said conductor forms a composite sheet together with said insulating material.

12. The circuit board for electronic parts as claimed in claim 11, wherein said insulating material contains an adhesive layer on the opposite side of said conductor.

13. The circuit board for electronic parts as claimed in claim 12, wherein a total thickness of said insulating material and said adhesive layer is from 10 to 100 $\mu$ m.

14. The circuit board for electronic parts as claimed in claim 10, wherein said conductor is a foil having a thickness of at least 10 $\mu$ m.--

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### REMARKS

#### IN THE DRAWINGS

Figures 1, 10, and 16A-B were indicated as being improperly cross-hatched. Figure 8 was indicated as containing an improper cross-section designator. Applicants also noted spelling error in Figures 5, 19 and 20, for which corrected thereto is proposed herein. Attached is a Drawing Change Authorization request containing markings in red indicating proposed changes to the Figures 1, 5, 10, 16A-B, 19 and 20.

These amendments are illustrative in nature and merely depict various aspects of the invention using the highly generalized graphic symbols provided in MPEP § 608.02. These Figures and amendments are not to be considered as limiting the disclosed invention in any way